

Replaces March 1998 version, DS4216-3.3

#### **APPLICATIONS**

- Induction Heating
- A.C. Motor Drives
- Inverters And Choppers
- Welding
- High Frequency Rectification
- UPS

#### FEATURES

- Double Side Cooling
- High Surge Capability
- Low Recovery Charge

#### **VOLTAGE RATINGS**

Type Number	Repetitive Peak Reverse Voltage V <sub>RRM</sub> V	Conditions
DF754 35	3500	$V_{RSM} = V_{RRM} + 100V$
DF754 34	3400	
DF754 32	3200	
DF754 30	3000	

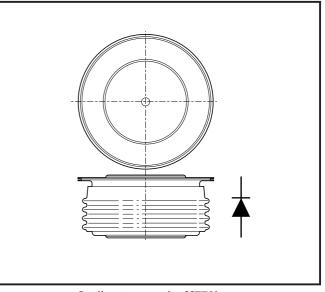
Lower voltage grades available.

#### **CURRENT RATINGS**

Symbol	Parameter	Conditions	Max.	Units			
Double Side Cooled							
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load, $T_{case} = 65^{\circ}C$	865	А			
I <sub>F(RMS)</sub>	RMS value	$T_{case} = 65^{\circ}C$	1360	А			
۱ <sub>۶</sub>	Continuous (direct) forward current	$T_{case} = 65^{\circ}C$	1200	A			
Single Side Cooled (Anode side)							
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load, $T_{case} = 65^{\circ}C$	515	А			
I <sub>F(RMS)</sub>	RMS value	$T_{case} = 65^{\circ}C$	800	А			
I <sub>F</sub>	Continuous (direct) forward current	T <sub>case</sub> = 65°C	670	А			

Fast	Recovery	Diode

# KEY PARAMETERS V<sub>RRM</sub> 3500V I<sub>F(AV)</sub> 865A I<sub>FSM</sub> 8000A Q<sub>r</sub> 1000µC t<sub>rr</sub> 6.0µs



Outline type code: M779b. See Package Details for further information.

## **DF754**

## SURGE RATINGS

Symbol	Parameter	Conditions	Max.	Units
I <sub>FSM</sub>	Surge (non-repetitive) forward current	10mc holf since with $0%$ V T = 150°C	8.0	kA
l <sup>2</sup> t	I <sup>2</sup> t for fusing	- 10ms half sine; with 0% $V_{RRM}$ , $T_j = 150^{\circ}C$	320 x 10 <sup>3</sup>	A <sup>2</sup> s
I <sub>FSM</sub>	Surge (non-repetitive) forward current	40 me holf since with $E00/1/$ T $4E00$	-	kA
l <sup>2</sup> t	I <sup>2</sup> t for fusing	- 10ms half sine; with 50% $V_{RRM}$ , $T_j = 150^{\circ}C$	-	A²s
I <sub>FSM</sub>	Surge (non-repetitive) forward current	10 me holf since with $100%$ // T $150%$	-	kA
l²t	I <sup>2</sup> t for fusing	- 10ms half sine; with 100% $V_{RRM}$ , $T_j = 150^{\circ}C$	-	A <sup>2</sup> s

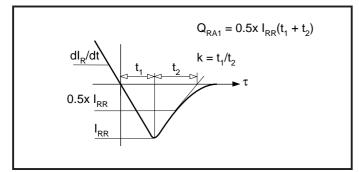
## THERMAL AND MECHANICAL DATA

Symbol	Parameter	Conditions		Min.	Max.	Units
		Double side cooled	dc	-	0.036	°C/W
R <sub>th(j-c)</sub>	Thermal resistance - junction to case	Single side cooled	Anode dc	-	0.069	°C/W
			Cathode dc	-	0.076	°C/W
5	Thermal resistance - case to heatsink	Clamping force 15kN with mounting compound	Double side	-	0.01	°C/W
R <sub>th(c-h)</sub>			Single side	-	0.02	°C/W
T <sub>vj</sub>	Virtual junction temperature	On-state (conducting)		-	150	°C
T <sub>stg</sub>	Storage temperature range			-55	175	°C
-	Clamping force			13.5	16.5	kN

## CHARACTERISTICS

Symbol	Parameter	Conditions	Тур.	Max.	Units
V <sub>fm</sub>	Forward voltage	At 1500A peak, T <sub>case</sub> = 25°C	-	2.5	V
I RRM	Peak reverse current	At $V_{\text{RRM}}$ , $T_{\text{case}} = 150^{\circ}\text{C}$	-	80	mA
t <sub>rr</sub>	Reverse recovery time		6.0	-	μs
Q <sub>RA1</sub>	Recovered charge (50% chord)	I <sub>F</sub> = 1000A, di <sub>RR</sub> /dt = 100A/μs	-	1000	μC
I <sub>RM</sub>	Reverse recovery current	T <sub>case</sub> = 150°C, V <sub>R</sub> = 100V	-	300	А
К	Soft factor		-	-	-
V <sub>TO</sub>	Threshold voltage	At $T_{vj} = 150^{\circ}C$	-	1.25	V
r <sub>T</sub>	Slope resistance	At $T_{vj} = 150^{\circ}C$	-	0.6	mΩ
$V_{FRM}$	Forward recovery voltage	di/dt = 1000A/µs, T <sub>j</sub> = 125°C	-	-	V

# DEFINITION OF K FACTOR AND $\mathbf{Q}_{_{\mathrm{RA1}}}$



## CURVES

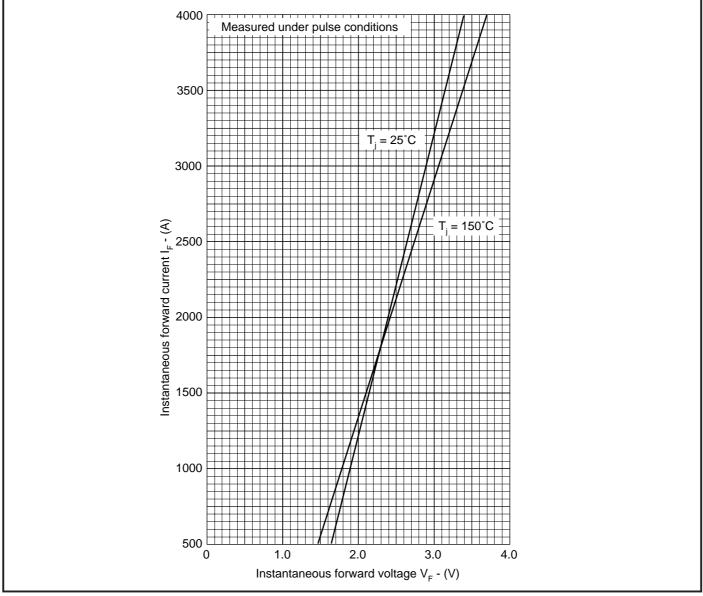


Fig.1 Maximum (limit) forward characteristics

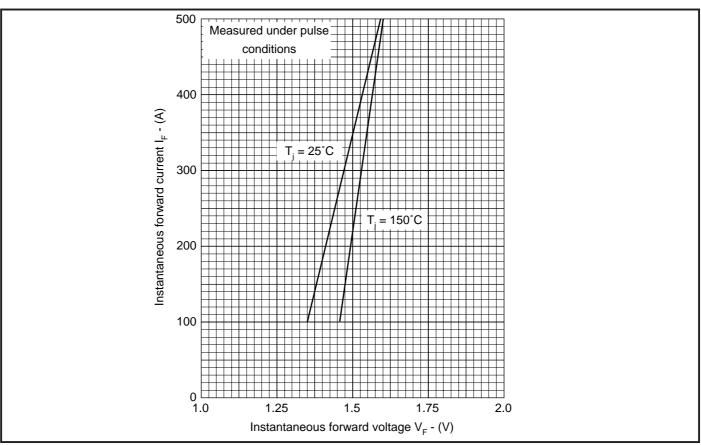


Fig.2 Maximum (limit) forward characteristics

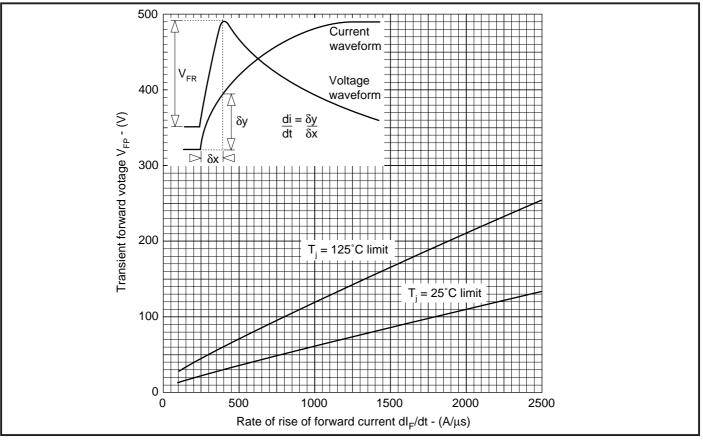


Fig.3 Transient forward voltage vs rate of rise of forward current

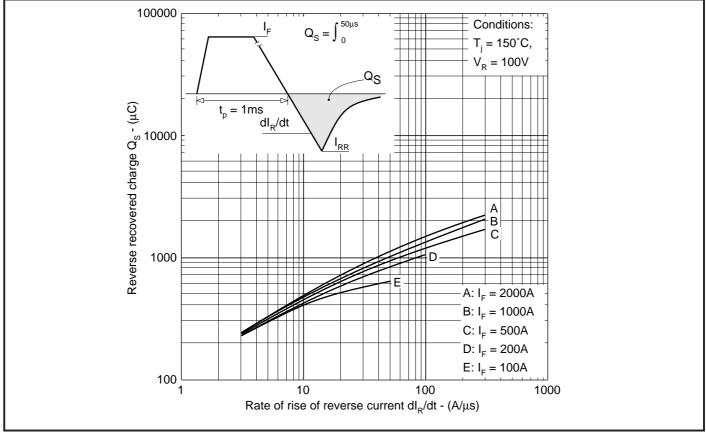
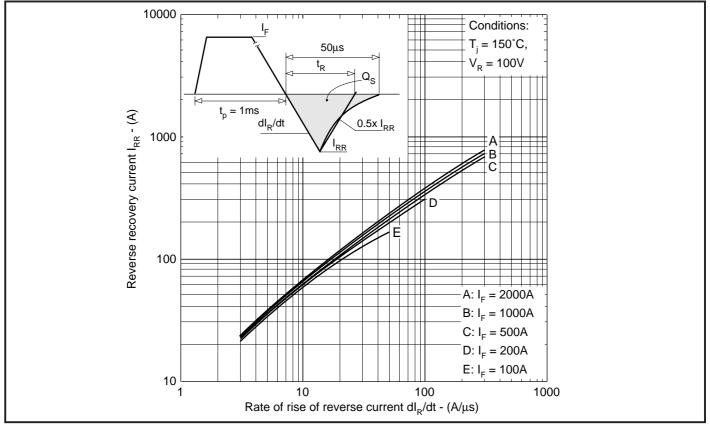


Fig.4 Recovered charge





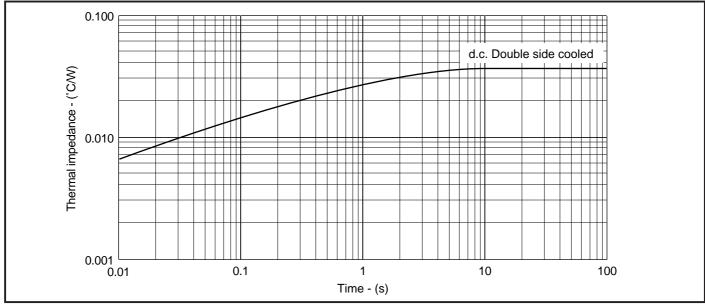
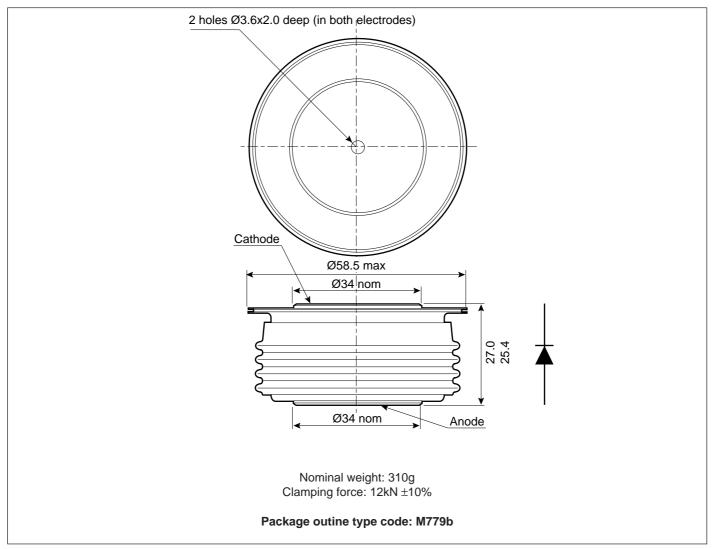


Fig.6 Maximum (limit) transient thermal impedance - junction to case - (°C/W)

#### **PACKAGE DETAILS**

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



#### **ASSOCIATED PUBLICATIONS**

Title	Application Note	
	Number	
Calculating the junction temperature or power semiconductors	AN4506	
Recommendations for clamping power semiconductors	AN4839	
Thyristor and diode measurement with a multi-meter	AN4853	
Use of $V_{TO}$ , $r_{T}$ on-state characteristic	AN5001	

#### POWER ASSEMBLY CAPABILITY

The Power Assembly group was set up to provide a support service for those customers requiring more than the basic semiconductor, and has developed a flexible range of heatsink / clamping systems in line with advances in device types and the voltage and current capability of our semiconductors.

We offer an extensive range of air and liquid cooled assemblies covering the full range of circuit designs in general use today. The Assembly group continues to offer high quality engineering support dedicated to designing new units to satisfy the growing needs of our customers.

Using the up to date CAD methods our team of design and applications engineers aim to provide the Power Assembly Complete solution (PACs).

#### **DEVICE CLAMPS**

Disc devices require the correct clamping force to ensure their safe operation. The PACs range offers a varied selection of preloaded clamps to suit all of our manufactured devices. This include cube clamps for single side cooling of 'T' 22mm

Clamps are available for single or double side cooling, with high insulation versions for high voltage assemblies.

Please refer to our application note on device clamping, AN4839

#### HEATSINKS

Power Assembly has it's own proprietary range of extruded aluminium heatsinks. They have been designed to optimise the performance or our semiconductors. Data with respect to air natural, forced air and liquid cooling (with flow rates) is available on request.

For further information on device clamps, heatsinks and assemblies, please contact your nearest Sales Representative or the factory.



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Preliminary Information: The product is in design and development. The datasheet represents the product as it is understood but details may change.

Advance Information: The product design is complete and final characterisation for volume production is well in hand.

No Annotation: The product parameters are fixed and the product is available to datasheet specification

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